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NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE3416 uses advanced trench technology to provide excellent $R_{\rm DS(ON)}$, low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications .It is ESD protested.

General Features

• $V_{DS} = 20V, I_D = 6.5A$

 $R_{DS(ON)}$ <40m Ω @ V_{GS} =1.8V

 $R_{DS(ON)}$ <33m Ω @ V_{GS} =2.5V

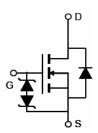
 $R_{DS(ON)}$ <27m Ω @ V_{GS} =4.5V

ESD Rating: 2000V HBM

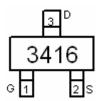
- High Power and current handing capability
- Lead free product is acquired
- Surface mount package

Application

- PWM application
- Load switch



Schematic diagram



Marking and pin assignment



SOT-23 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
3416	NCE3416	SOT-23	Ø180mm	8mm	3000 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

7 1000 1010 1110 1110 111 11 11 11 11 11					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	20	V		
Gate-Source Voltage	V _G s	±12	V		
Drain Current-Continuous	I _D	6.5	Α		
Drain Current-Pulsed (Note 1)	I _{DM}	30	Α		
Maximum Power Dissipation	P _D	1.4	W		
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$ C		

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	R _{θJA}	89	°C/W
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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	20		-	V



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Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±10V,V _{DS} =0V	-	-	±10	μA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	0.45	0.7	1.0	V
	R _{DS(ON)}	V _{GS} =4.5V, I _D =6.5A	-	17	27	mΩ
Drain-Source On-State Resistance		V _{GS} =2.5V, I _D =5.5A	-	21	33	mΩ
		V _{GS} =1.8V, I _D =5A	-	28	40	mΩ
Forward Transconductance	9 FS	V _{DS} =5V,I _D =6.5A	8	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	\/ -10\/\/ -0\/	-	660	-	PF
Output Capacitance	Coss	V_{DS} =10V, V_{GS} =0V, F=1.0MHz	-	160	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0WHZ	-	87	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	0.5		nS
Turn-on Rise Time	t _r	V_{DD} =10V,R _L =1. 5 Ω V_{GS} =5V,R _{GEN} =3 Ω	-	1		nS
Turn-Off Delay Time	t _{d(off)}		-	12		nS
Turn-Off Fall Time	t _f		-	4		nS
Total Gate Charge	Qg	V _{DS} =10V,I _D =6.5A,	-	8		nC
Gate-Source Charge	Q _{gs}		-	2.5	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =4.5V	-	3	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =6.5A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	6.5	Α

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width $\leq 300 \mu s$, Duty Cycle $\leq 2\%$.
- 4. Guaranteed by design, not subject to production



Typical Electrical and Thermal Characteristics

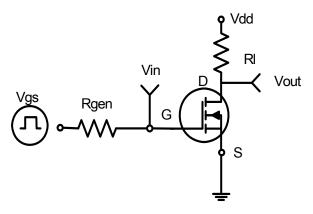


Figure 1:Switching Test Circuit

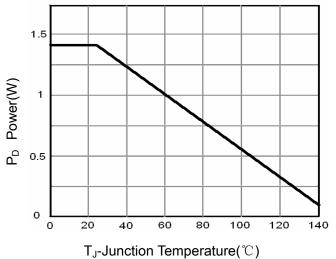
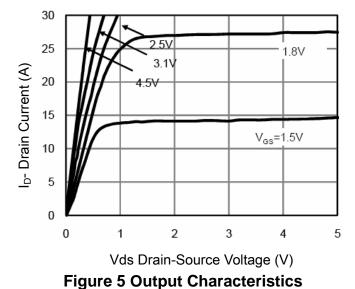


Figure 3 Power Dissipation



 $t_{d(on)}$ $t_{d(off)}$ t_{d

Figure 2:Switching Waveforms

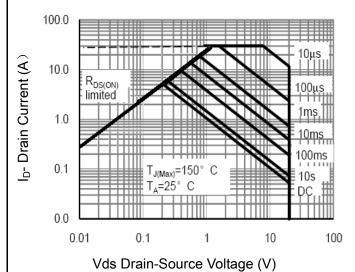


Figure 4 Safe Operation Area

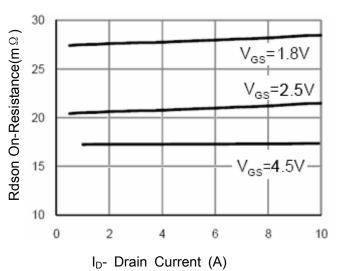


Figure 6 Drain-Source On-Resistance



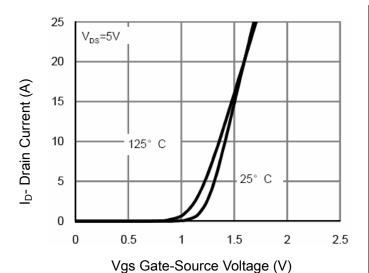
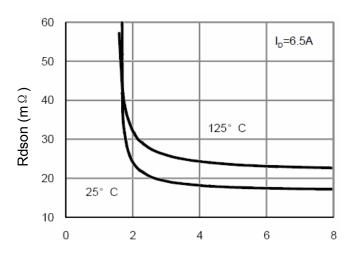
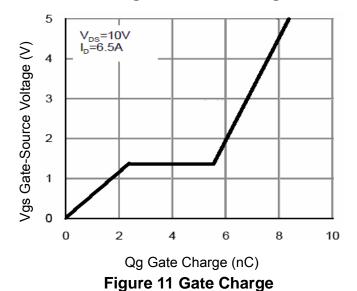


Figure 7 Transfer Characteristics



Vgs Gate-Source Voltage (V)
Figure 9 Rdson vs Vgs



1.6 I_D=6A Normalized On-Resistance V_{GS}=2.5V 1.4 V_{GS}=4.5V 1.2 1.0 8.0 25 50 75 100 125 150 175

 T_J -Junction Temperature(${}^{\circ}$ C) Figure 8 Drain-Source On-Resistance

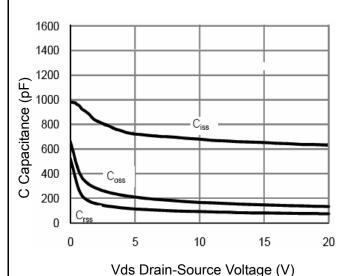


Figure 10 Capacitance vs Vds

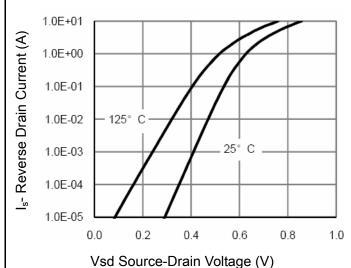


Figure 12 Source- Drain Diode Forward

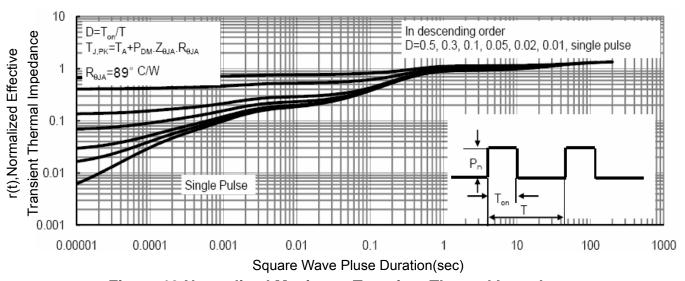
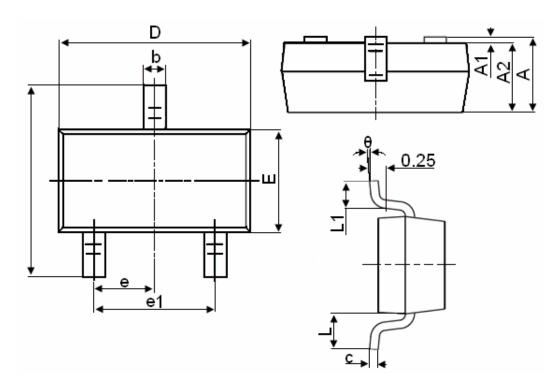


Figure 13 Normalized Maximum Transient Thermal Impedance



SOT-23 Package Information



Symbol	Dimensions in Millimeters				
Symbol	MIN.	MAX.			
Α	0.900	1.150			
A1	0.000	0.100			
A2	0.900	1.050			
b	0.300	0.500			
С	0.080	0.150			
D	2.800	3.000			
E	1.200	1.400			
E1	2.250	2.550			
е		0.950TYP			
e1	1.800	2.000			
L	0.550REF				
L1	0.300	0.500			
θ	0°	8°			

Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- $5. \ Controlling \ dimension \ is \ millimeter, \ converted \ inch \ dimensions \ are \ not \ necessarily \ exact.$



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